

Description

The FMXA-4203S is a fast recovery diode of 300 V / 20 A. The maximum $t_{\rm rr}$ of 25 ns is realized by optimizing a life-time control.

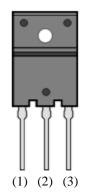
Package

TO3PF-3L

Features

• \	$I_{\rm RM}$ -	 	 	 	 	(300	V
• I	F(AV)	 	 	 	 		- 20	A
• f.		 	 	 	 		25	ns
- 1	.1						_	

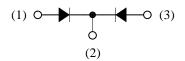
• Bare lead frame: Pb-free (RoHS compliant)



Not to scale

Applications

- Secondary Side Rectifier Diode (Flyback Converter, LLC Converter, etc.)
- Freewheel Diode (Offline Buck and Buck-boost Converter)



- (1) Anode
- (2) Cathode
- (3) Anode

FMXA-4203S

Absolute Maximum Ratings

Unless otherwise specified, $T_A = 25$ °C

Parameter	Symbol	Rating	Unit	Conditions
Peak Repetitive Reverse Voltage ⁽¹⁾	V _{RSM}	300	V	
Repetitive Reverse Voltage ⁽¹⁾	V_{RM}	300	V	
Average Forward Current	I _{F(AV)}	20	A	See Figure 1 and Figure 2
Surge Forward Current ⁽¹⁾	I_{FSM}	100	A	Half cycle sine wave, positive side, 10 ms, 1 shot
I ² t Limiting Value ⁽¹⁾	I^2t	50	A^2s	$1 \text{ ms} \le t \le 10 \text{ ms}$
Junction Temperature	T _J	-40 to 150	°C	
Storage Temperature	T_{STG}	-40 to 150	°C	

Electrical Characteristics

Unless otherwise specified, $T_A = 25$ °C

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage Drop ⁽¹⁾	V	$T_J = 25 ^{\circ}\text{C}, I_F = 10 \text{A}$	_	_	1.30	V
Forward Voltage Drop	V_{F}	$T_J = 100 ^{\circ}\text{C}, I_F = 10 \text{A}$	_	1.03	_	V
Reverse Leakage Current ⁽¹⁾	I_R	$V_R = V_{RM}$	_		100	μΑ
Reverse Leakage Current Under High Temperature ⁽¹⁾	$H \cdot I_R$	$V_R = V_{RM}, T_J = 150 ^{\circ}C$	_		30	mA
Reverse Recovery Time ⁽¹⁾	t _{rr}	$I_F = I_{RP} = 500 \text{ mA}$ 90% recovery point, $T_J = 25 ^{\circ}\text{C}$	_		25	ns
Thermal Resistance ⁽²⁾	R _{th(J-C)}		_		2.0	°C/W

Specifies a value per chip; the FMXA-4203S consists of two chips. $^{(2)}R_{th (J-C)}$ is thermal resistance between junction and the case. The case temperature is measured at the back side near the screw hole.

Rating and Characteristic Curves

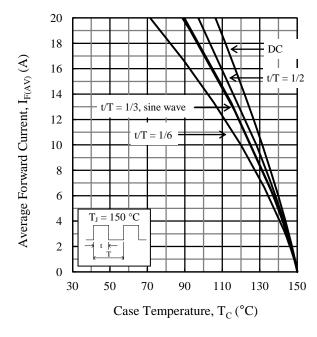


Figure 1. $I_{F(AV)}$ vs. T_C Typical Characteristics $(V_R = 0 \ V)$

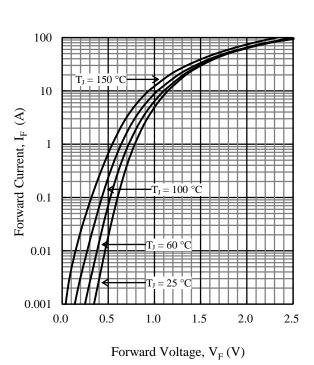


Figure 3. V_F vs. I_F Typical Characteristics

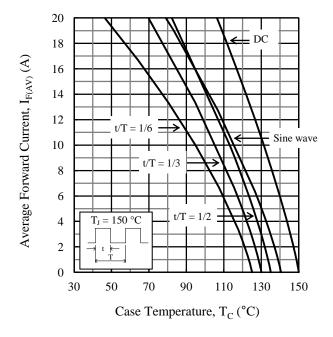


Figure 2. $I_{F(AV)}$ vs. T_C Typical Characteristics $(V_R = 300 \ V)$

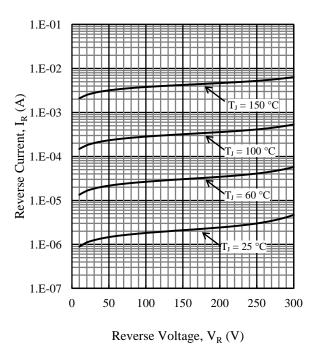
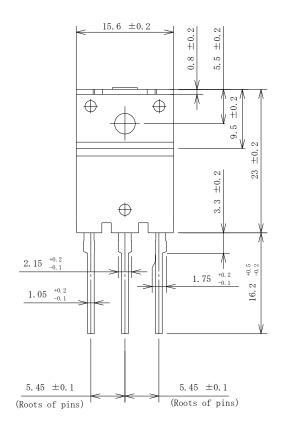
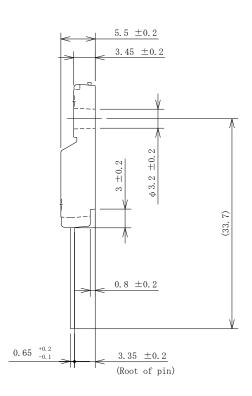


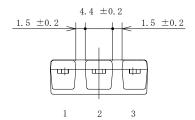
Figure 4. V_R vs. I_R Typical Characteristics

Physical Dimensions

• TO3PF-3L







NOTES:

- Dimensions in millimeters
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time, within the following limits:

Flow: 260 ± 5 °C / 10 ± 1 s, 2 times

Soldering Iron: 380 ± 10 °C / 3.5 ± 0.5 s, 1 time

Soldering should be at a distance of at least 1.5 mm from the body of the product.

- Recommended screw torque for TO3PFF: 0.686 N·m to 0.882 N·m (7 kgf·cm to 9 kgf·cm)

Marking Diagram

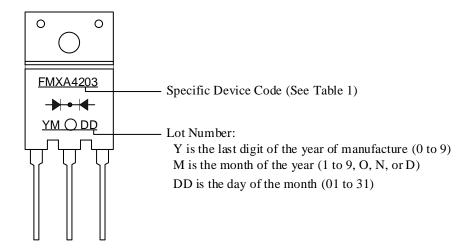


Table 1. Specific Device Code

Specific Device Code	Part Number			
FMXA4203	FMXA-4203S			

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